## **EP0408 Dielectric Coating**

EP0408 is a hybrid molecule with an inorganic silsequioxane at the core, and organic epoxycyclohexyl groups attached at the corners of the cage. It is a yellow, semi-solid compound. It is soluble in many polar organic solvents, and aromatic and aliphatic epoxy resins, but is insoluble in non-polar organic solvents. EP0408 can be cured with aromatic and aliphatic amines, and provide increased use temperature, excellent water and solvent resistance, and enhanced thermomechanical performance. EP0408 provides a resilient, strong inorganic/organic hybrid dielectric for use in microfabrication. Its thermal and chemical stability allow for a tough and durable overcoat. The combination of high modulus, chemical and thermal stability, and high selectivity are desirable attributes, making EP0408 an interesting permanent dielectric or temporary etch mask.

## PHYSICAL PROPERTIES

Molecular/Chemical Formula:  $(C_8H_{13}O)_n(SiO_{15})_n$  n=8, 10, 12

Molecular Weight: 1418 - 2127

**Epoxy Equivalent Weight:** 177

Clear, pale yellow/orange, Appearance:

semi-solid

Density: 1.24 g/mL

Refractive index: 1.52

Viscosity (@ 60°C): 500 Poise

Thermal Stability (5% weight loss): 403°C

THF, chloroform, isopropanol Solvent Solubility:

Solvent Insolubility: hexane

Resin Solubility: aromatic and aliphatic

epoxy resins

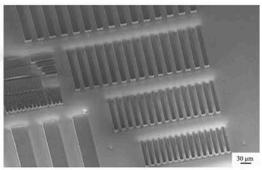
## **AVAILABILITY**

EP0408 is available in R&D and bulk quantites. Contact us at info@hybridplastics.com for a quote.

## WARRANTY

The information contained herein is believed to be accurate and reliable. However, the user is responsible for determining the suitability and use of the final formulations/products. Plastics® warrants that its products will meet specifications, but not merchantability or fitness for use.

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CHF,	<b>POSS Etch Rate</b>	PPC/POSS
concentration	(µm/min)	Selectivity
0%	0.003	220
1%	0.007	95
2%	0.02	33
4%	0.023	29
6%	0.027	24
8%	0.04	16.5
10%	0.05	13.2

- \* Polypropylene carbonate etch rate = 0.66µm/min
- \* 250W O, plasma

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